January 2001

## Si4467DY

SEMICONDUCTOR IM

## P-Channel 1.8V Specified PowerTrench<sup>®</sup> MOSFET

## **General Description**

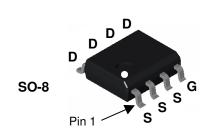
This P-Channel 1.8V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (1.8V - 8V).

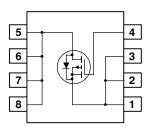
## Applications

- Power management
- Load switch
- Battery protection

## Features

- -13.5 A, -20 V.  $R_{DS(ON)} = 8.5 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$  $R_{DS(ON)} = 10.5 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$  $R_{DS(ON)} = 14 \text{ m}\Omega @ V_{GS} = -1.8 \text{ V}$
- Fast switching speed
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High current and power handling capability





## Absolute Maximum Ratings TA=25°C unless otherwise noted

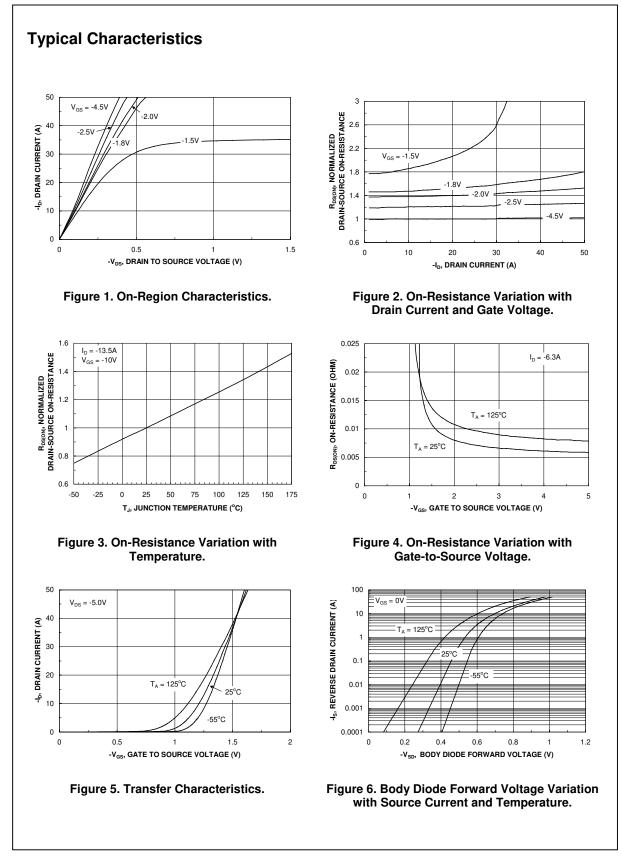
Symbol		Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain-Sourc	e Voltage	-20	V	
V <sub>GSS</sub>	Gate-Sourc	e Voltage	±8 V		
ID	Drain Curre	nt – Continuous	(Note 1a)	-13.5	А
		– Pulsed		-50	
P <sub>D</sub>	Power Diss	pation for Single Opera	ation (Note 1a)	2.5	W
			(Note 1b)	1.5	
			(Note 1c)	1.2	
T <sub>J</sub> , T <sub>STG</sub>	Operating a	nd Storage Junction Te	-55 to +175	°C	
Therma	I Charac	teristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)			50	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1c)			125	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case (Note 1)			25	°C/W
Packag	e Markin	g and Ordering	g Information		
Device Marking		Device	Reel Size	Tape width	Quantity
4467		Si4467DY	13"	12mm	2500 units

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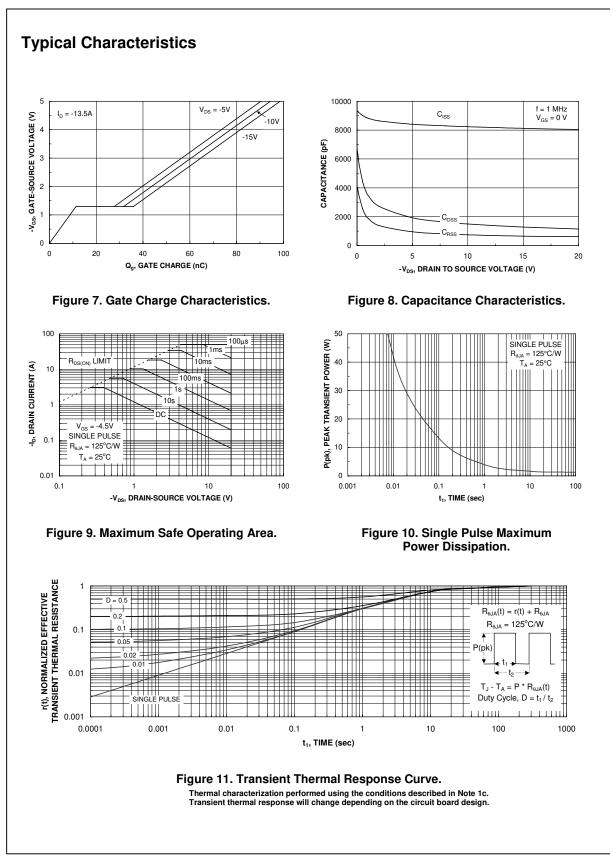
Si4467DY

-12 -12 40.6 3 6.7 8.0 9.8 9.0 9.8 9.0 0 70 8237	-1 100 -100 -1.5 8.5 10.5 14 13	V   mV/°C   μA   nA   nA   mV/°C   mV/°C   mΩ   A   S
-12 -12 4 -0.6 3 6.7 8.0 9.8 9.0 9.0 0 70	-1 100 -100 -1.5 8.5 10.5 14 13	mV/°C   μA   nA   nA   mV/°C   mV/°C   mΩ
40.6 3 6.7 8.0 9.8 9.0 0 70	-1 100 -100 -1.5 8.5 10.5 14 13	μA   nA   nA   NA   MV/°C   mΩ   A
3 6.7 8.0 9.8 9.0 0 70	100 -100 -1.5 8.5 10.5 14 13	nA nA V mV/°C mΩ A
3 6.7 8.0 9.8 9.0 0 70	-100 -1.5 8.5 10.5 14 13	nA   V   mV/°C   mΩ   A
3 6.7 8.0 9.8 9.0 0 70	-1.5 8.5 10.5 14 13	V mV/°C mΩ A
3 6.7 8.0 9.8 9.0 70	8.5 10.5 14 13	mV/°C mΩ A
3 6.7 8.0 9.8 9.0 70	8.5 10.5 14 13	mV/°C mΩ A
6.7 8.0 9.8 9.0 70	10.5 14 13	mΩ
8.0 9.8 9.0 70	10.5 14 13	A
9.8 9.0 70	14 13	
9.0 ) 70	13	
70		
70		
8237		
	'	pF
1497		pF
750	1	pF
	1	<u> </u>
20	36	ns
24	38	ns
300	480	ns
140	224	ns
86	120	nC
20	+	nC
11	1	nC
	-2.1	А
-0.6	-12	V
	140 86 20 11 −0.6 ed as the sol	140 224   86 120   20 11   -2.1

2. Pulse Test: Pulse Width < 300 $\mu s,$  Duty Cycle < 2.0%



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